



T-1 3/4 (5mm) SOLID STATE LAMP

Features

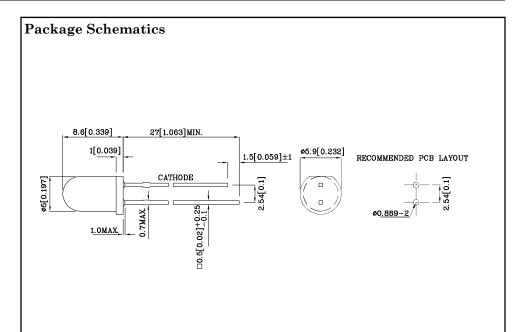
- Radial / Through hole package
- \bullet Reliable & robust
- Low power consumption
- Available on tape and reel
- 5V internal resistor.
- RoHS Compliant







ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		VG (AlGaInP)	Unit		
Reverse Voltage	$V_{\rm R}$	5	V		
Forward Voltage	V_{F}	6	V		
Power Dissipation	P_{D}	85	mW		
Operating Temperature	$T_{\rm A}$	T_A -40 ~ +70			
Storage Temperature	Tstg	-40 ~ +85	°C		
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds				
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds				

Operating Characteristics (T_A =25°C)		VG (AlGaInP)	Unit
Forward Current (Typ.) (V _F =5V)	I_{F}	11.5	mA
Forward Current (Max.) (V _F =5V)	I_{F}	17.5	mA
Reverse Current (Max.) $(V_R=5V)$	I_R	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (V _F =5V)	λΡ	574*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (V _F =5V)	λD	570*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (V _F =5V)	Δλ	20	nm

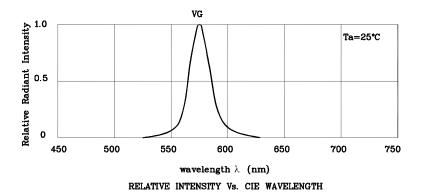
Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \text{Luminous Intensity} \\ \text{CIE127-2007*} \\ \text{(V}_{\text{F}}\text{=}5\text{V)} \\ \text{mcd} \end{array}$		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
XLVG12D5V	Green	AlGaInP	Green Diffused	25*	64*	574*	30°

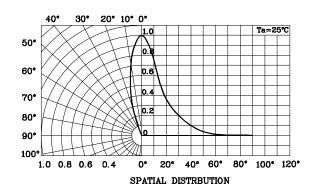
^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

Dec 23,2013 XDSA7656 V5-Z Layout: Maggie L.

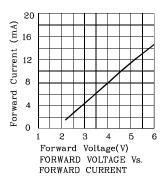


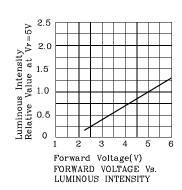


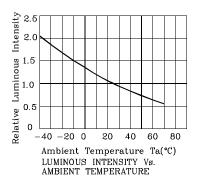




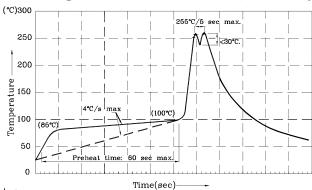
❖ VG











Notes:

- Notes. I. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of $260^{\circ}C$ 2. Peak wave soldering temperature between $245^{\circ}C \sim 255^{\circ}C$ for 3 sec
- (5 sec max).
- $3.\mathrm{Do}$ not apply stress to the epoxy resin while the temperature is above $85^{\circ}\mathrm{C}$. $4.\mathrm{Fixtures}$ should not incur stress on the component when mounting and
- during soldering process. 5.SAC 305 solder alloy is recommended.
- 6. No more than one wave soldering pass.

Remarks:

If special sorting is required (e.g. binning based on Luminous intensity/ luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

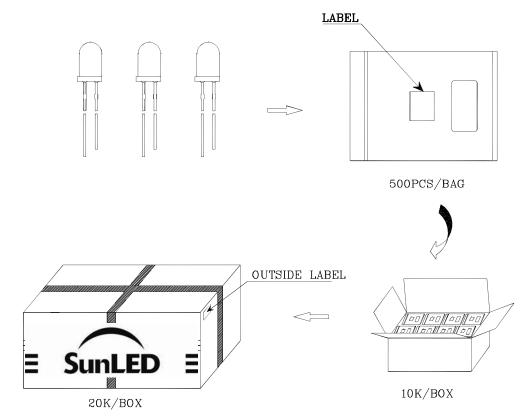
- 1. Wavelength: +/-1nm
- 2. Luminous intensity/ luminous flux: +/-15%

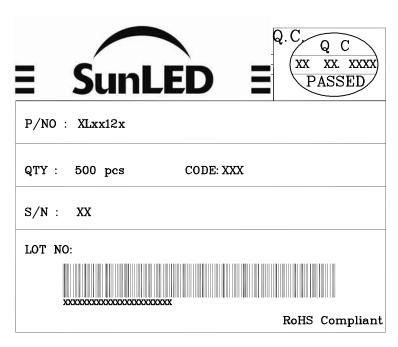
Note: Accuracy may depend on the sorting parameters.





PACKING & LABEL SPECIFICATIONS





TERMS OF USE

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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
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- 6. Additional technical notes are available at http://www.SunLEDusa.com/TechnicalNotes.asp

Dec 23,2013